

TPS5450EVM-254 5-A, SWIFT™ Regulator Evaluation Module

Contents

1	Introduction	1
2	Test Setup and Results	3
3	Board Layout	7
4	Schematic and Bill of Materials	12

List of Figures

1	Measured Efficiency, TPS5450	4
2	Load Regulation	4
3	Line Regulation	5
4	Load Transient Response, TPS5450	5
5	Measured Loop Response, TPS5450, VIN = 25 V	6
6	Measured Output Voltage Ripple, TPS5450	6
7	Input Voltage Ripple, TPS5450	7
8	Top-Side Layout	8
9	Internal Layer 2	9
10	Internal Layer 3	10
11	Bottom-Side Layout (Looking From Top Side)	11
12	Top-Side Assembly	12
13	TPS5450EVM-254 Schematic	13

List of Tables

1	Input Voltage and Output Current Summary	2
2	TPS5450EVM-254 Performance Specification Summary	2
3	Output Voltages Available	3
4	EVM Connectors and Test Points	3
5	TPS5450EVM-254 Bill of Materials	14

1 Introduction

This user's guide contains background information for the TPS5450 as well as support documentation for the TPS5450EVM-254 evaluation module (HPA254). Also included are the performance specifications, the schematic, and the bill of materials for the TPS5450EVM-254.

1.1 Background

The TPS5450 dc/dc converter is designed to provide up to a 5-A output from an input voltage source of 5.5 V to 36 V. Rated input voltage and output current range for the evaluation module is given in Table 1. This evaluation module is designed to demonstrate a typical printed-circuit-board application using the TPS5450 regulator and does not reflect the full range of possible input and output voltages that may be used when designing with this part. The switching frequency is internally set at a nominal 500 kHz. The

SWIFT, PowerPAD are trademarks of Texas Instruments.

1



Introduction

high-side MOSFET is incorporated inside the TPS5450 package along with the gate drive circuitry. The low drain-to-source on resistance of the MOSFET allows the TPS5450 to achieve high efficiencies and helps to keep the junction temperature low at high output currents. The compensation components are provided internal to the integrated circuit (IC), whereas an external divider allows for an adjustable output voltage. Additionally, the TPS5450 provides an enable input. The absolute maximum input voltage for the TPS5450 is 40 V.

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE
TPS5450EVM-254	VIN = 10 V to 31 V	0 A to 5 A

Table 1. Input Voltage and Output Current Summary

1.2 Performance Specification Summary

A summary of the TPS5450EVM-254 performance specifications is provided in Table 2. Specifications are given for an input voltage of VIN = 12 V and an output voltage of 5 V, unless otherwise specified. The TPS5450EVM-254 is designed and tested for VIN = 10 V to 31 V. The ambient temperature is 25°C for all measurements, unless otherwise noted. Maximum operating input voltage for the TPS5450EVM-254 is 36 V.

SPECIFICATION		TEST CONDITIONS	MIN	TYP	MAX	UNIT
VIN voltage range			10		31	V
Output voltage set point				5.0		V
Output current range			0		5	А
Line regulation		I _O = 2.5 A, VIN = 10 V - 31 V		±0.04%		
Load regulation		$VIN = 15 V$, $I_0 = 0 A$ to 5 A		-0.02% +0.11%		
Load transient response	Voltage change	I _O = 1.25 A to 3.75 A		-60		mV
	Recovery time			160		ms
	Voltage change	I _O = 3.75 A to 1.25 A		60		mV
	Recovery time			160		ms
Loop bandwidth		VIN = 25 V, I _O = 2.5 A		17.0		kHz
Phase margin		VIN = 25 V, I _O = 2.5 A		58		0
Input ripple voltage		I _O = 5 A		400		mV _{PP}
Output ripple voltage		I _O = 5 A		30		mV _{PP}
Output rise time				7		ms
Operating frequency				500		kHz
Max efficiency		VIN = 10 V, V _O = 5 V, I _O = 1 A		93.4%		

Table 2. TPS5450EVM-254 Performance Specification Summary

1.3 Modifications

The TPS5450EVM-254 is designed to demonstrate the small size that can be attained when designing with the TPS5450. A few changes can be made to this module.

1.3.1 Output Voltage Setpoint

To change the output voltage of the EVM, it is necessary to change the value of resistor R2. Changing the value of R2 can change the output voltage above 1.25 V. The value of R2 for a specific output voltage can be calculated using Equation 1.

$$R2 = 10 \text{ k}\Omega \times \frac{1.221 \text{ V}}{\text{V}_{\text{O}} - 1.221 \text{ V}}$$

Table 3 lists the R2 values for some common output voltages. Note that VIN must be in a range so that the minimum on-time is greater than 200 ns, and the maximum duty cycle is less than 87%. The values given in Table 3 are standard values, not the exact value calculated using Equation 1.

Output Voltage (V)	R_2 Value (k Ω)				
1.8	21.5				
2.5	9.53				
3.3	5.90				
5	3.16				

Table 3. Ou	Itput Voltages	Available
-------------	----------------	-----------

1.3.2 Input Voltage Range

The EVM is designed to operate from a nominal 10 to 31 V input voltage range. The TPS5450 is specified to operate over an input voltage range of 5.5 V to 36 V.

2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS5450EVM-254 evaluation module. The section also includes test results typical for the TPS5450EVM-254 and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and startup.

2.1 Input / Output Connections

The TPS5450EVM-254 is provided with input/output connectors and test points as shown in Table 4. A power supply capable of supplying 5 A should be connected to J1 through a pair of 20 AWG wires. The load should be connected to J3 through a pair of 20 AWG wires. The maximum load current capability should be 5 A. Wire lengths should be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the VIN input voltages with TP2 providing a convenient ground reference. TP3 is used to monitor the output voltage with TP4 as the ground reference.

Reference Designator	Function
J1	VIN, 12 V nominal, 10 V to 31 V
J2	OUT, 5 V at 5 A maximum
JP1	2-pin header for enable. Connect EN to ground to disable, open to enable.
TP1	VIN test point at VIN connector
TP2	GND test point at VIN
TP3	Output voltage test point at OUT connector
TP4	GND test point at OUT connector
TP5	Test point between voltage divider network and R3. Used for loop response measurements.
TP6	PH test point

Table 4. EVM Connectors and Test Point	Table 4	. EVM	Connectors	and	Test	Points
--	---------	-------	------------	-----	------	--------

2.2 Efficiency

The TPS5450EVM-254 efficiency peaks at load current of about 1 to 2 A, depending on the input voltage, and then decreases as the load current increases towards full load. Figure 1 shows the efficiency for the TPS5450EVM-254 at an ambient temperature of 25°C. The efficiency is lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the MOSFETs.



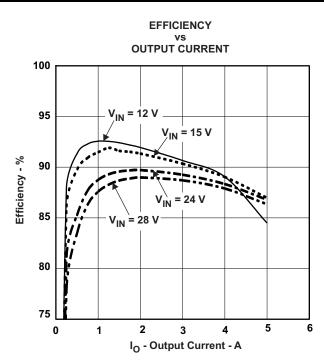
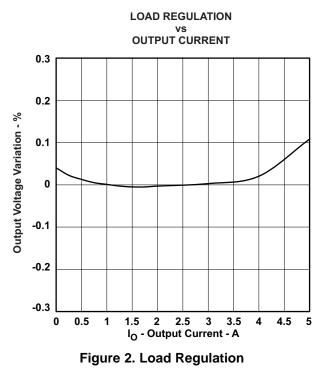
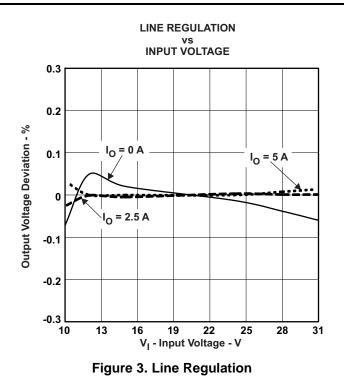


Figure 1. Measured Efficiency, TPS5450

2.3 Output Voltage Regulation

The output voltage load regulation of the TPS5450EVM-254 is shown in Figure 2 for an input voltage of 15 V; the output voltage line regulation is shown in Figure 3. Measurements are given for an ambient temperature of 25°C.





2.4 Load Transients

The TPS5450EVM-254 response to load transients is shown in Figure 4. The current step is from 25% to 75% of maximum rated load. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

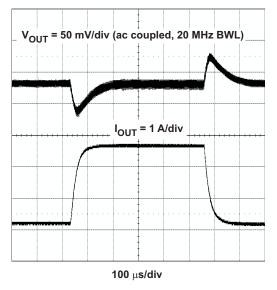


Figure 4. Load Transient Response, TPS5450



2.5 Loop Characteristics

The TPS5450EVM-254 loop-response characteristics are shown in Figure 5. The gain and phase plot is shown for a VIN voltage of 25 V.

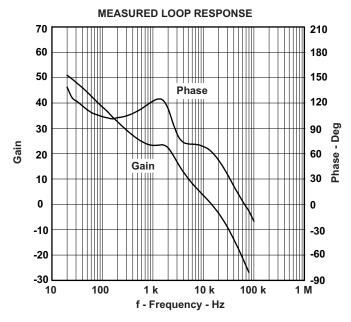


Figure 5. Measured Loop Response, TPS5450, VIN = 25 V

2.6 Output Voltage Ripple

The TPS5450EVM-254 output voltage ripple is shown in Figure 6. The input voltage is VIN = 25 V for the TPS5450. Output current is the rated full load of 5 A. Voltage is measured directly across output capacitors.

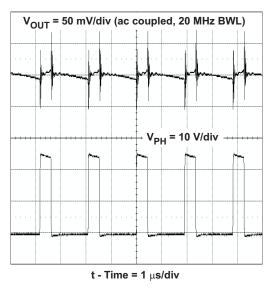


Figure 6. Measured Output Voltage Ripple, TPS5450



2.7 Input Voltage Ripple

The TPS5450EVM-254 output voltage ripple is shown in Figure 7. The input voltage is VIN = 25 V for the TPS5450. Output current for each device is at full rated load of 5 A.

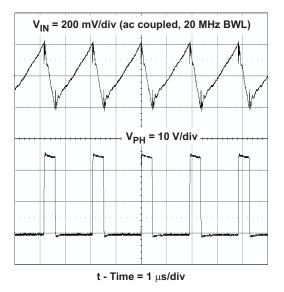


Figure 7. Input Voltage Ripple, TPS5450

2.8 Enable Control

The output may be inhibited by using a jumper at JP1 to tie EN to GND. When the jumper is removed, EN is released and the slow-start voltage begins to ramp up at the internally set rate. When the EN voltage reaches the enable-threshold voltage (1.3 V max), the start-up sequence begins.

3 Board Layout

This section provides a description of the TPS5450EVM-254 board layout and layer illustrations.

3.1 Layout

The board layout for the TPS5450EVM-254 is shown in Figure 8 through Figure 12. The topside layer of the TPS5450EVM-254 is laid out in a manner typical of a user application. The all four layers are 2-oz. copper.

The top layer contains the main power traces for VIN connection to the IC, VOUT, and VPHASE. Also on the top layer are connections for the remaining pins of the TPS5450 and a large area filled with ground. The internal layer 2 and bottom layers contain dedicated ground planes. the internal layer 3 is mostly ground and also contains the VIN connection from the edge connector J1, the EN trace to JP1, and the voltage sense trace. The bottom and internal ground traces are primarily used for thermal dissipation are connected to the top layer ground with four vias directly under the TPS5450 device to provide a thermal path from the PowerPAD[™] land to ground.

The input decoupling capacitors (C1, C4 and C5) and bootstrap capacitor (C2) are all located as close to the IC as possible. In addition, the voltage set point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the VOUT connection of the output connector J2.



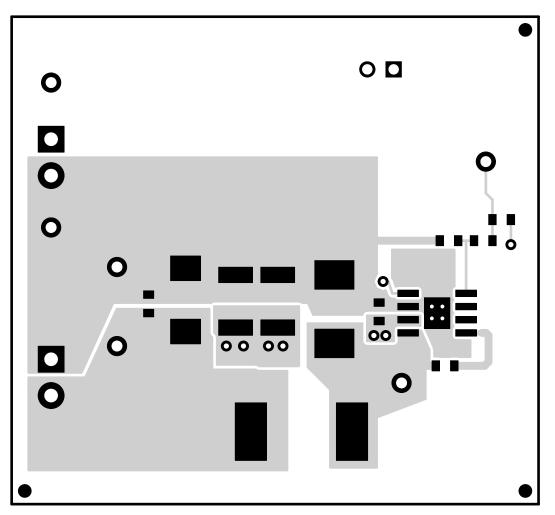


Figure 8. Top-Side Layout



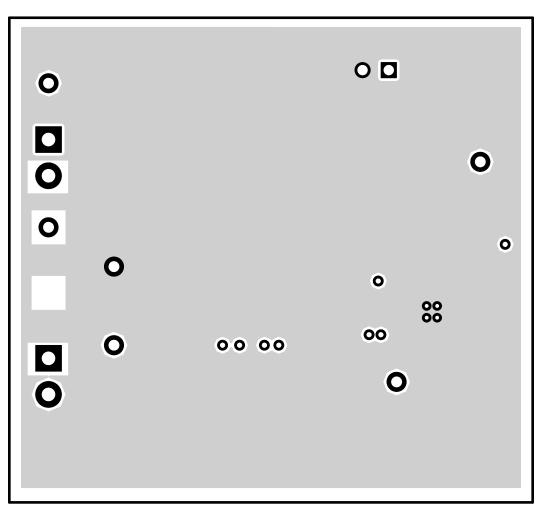


Figure 9. Internal Layer 2

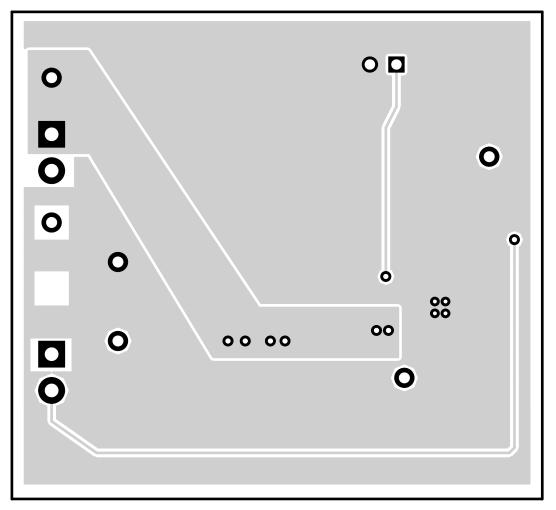


Figure 10. Internal Layer 3



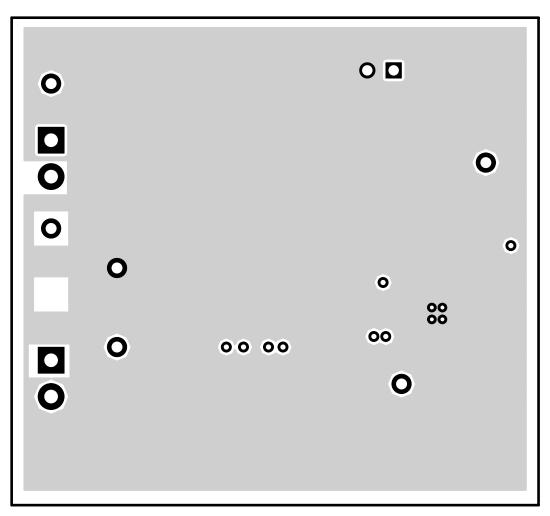


Figure 11. Bottom-Side Layout (Looking From Top Side)



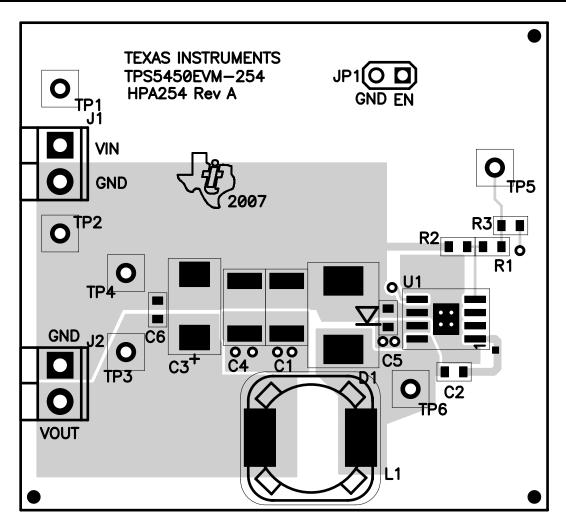


Figure 12. Top-Side Assembly

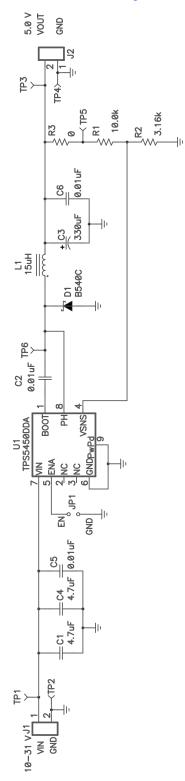
4 Schematic and Bill of Materials

The TPS5450EVM-254 schematic and bill of materials are presented in this section.



4.1 Schematic

The schematic for the TPS5450EVM-254 is shown in Figure 13.







929950-00

Schematic and Bill of Materials

4.2 Bill of Materials

1

_

The bill of materials for the TPS5450EVM-254 is given by Table 5.

Shunt, 100mil, Black

REF DES Count Value Description Size Part Number MFR 2 C1, C4 4 μF Capacitor, Ceramic, 50V, X5R,20% 1812 C4532X5R1H475MT TDK 3 C2, C5, C6 0.01 μF Capacitor, Ceramic, 50V, X7R, 10% 0603 C1608X7R1H103K TDK 330 μF Capacitor, POSCAP, 10V, 35milliohm, 20% 7343(D) 10TPB330M C3 1 Sanyo D1 SMC B540C-13-F 1 Diode, Schottky, 5A, 40V Diodes Inc ED1514 2 J1, J2 Terminal Block, 2 pin, 6A, 3.5mm 0.27 x 0.25 OST 0.100 x 2 JP1 PTC36SAAN Sullins 1 Header, 2-pin, 100mil spacing, (36-pin strip) 1 L1 15 μH Inductor, SMT, 5.65A, 26.4milliohm 0.405 sq inch CDRH127/LD-150 Sumida 1 R1 10.0 k Resistor, Chip, 1/16W, 1% 0603 Std Std R2 3.24 k Resistor, Chip, 1/16W, 1% 0603 Std Std 1 1 R3 0 Resistor, Chip, 1/16W, 5% 0603 Std Std TP1, TP3, Test Point, Red, Thru Hole Color Keyed 0.100 x 0.100 4 5000 Keystone TP5, TP6 2 TP2, TP4 Test Point, Black, Thru Hole Color Keyed 0.100 x 0.100 5001 Keystone 1 U1 IC, Switching Step-Down Regulator, 5.5V-36V, 5A SO8[DDA] TPS5450DDA ТΙ HPA254 PCB, 2 In x 1.85 In x 0.062 In 1 Any _

0.100

ЗM

Table 5. TPS5450EVM-254 Bill of Materials

EVALUATION BOARD/KIT IMPORTANT NOTICE

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user is not exclusive.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit <u>www.ti.com/esh</u>.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated

EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 10 V to 31 V and the output voltage range of 1.8 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 55°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buvers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Telephony	www.ti.com/telephony
Low Power Wireless	www.ti.com/lpw	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated